

AMENDMENT TRANSMITTAL LETTER (Large Entity)

Applicant(s): Toshimichi Kurihara, et al.

Docket No.

14872

Serial No.

09/942,445

Filing Date

August 30, 2001

Examiner

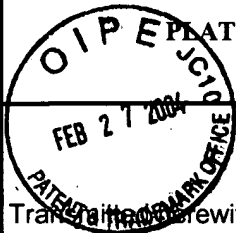
Nema O. Berezny

Group Art Unit

2813

Invention: SEMICONDUCTOR DEVICE IN A RESIN SEALED PACKAGE WITH A RADIATING

PLATE AND MANUFACTURING METHOD THEREOF

**TO THE COMMISSIONER FOR PATENTS:**

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	14 -	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	3 -	3 =	0 x	\$86.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. _____ in the amount of _____
- ☐ A check in the amount of _____ to cover the filing fee is enclosed.
- ☒ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. **19-1013/SSMP**
- ☒ Any additional filing fees required under 37 C.F.R. 1.16.
- ☒ Any patent application processing fees under 37 CFR 1.17.

Signature

Dated: February 24, 2004

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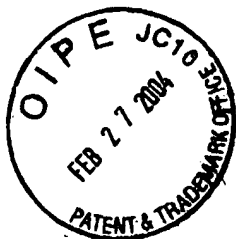
I certify that this document and fee is being deposited on Feb. 24, 2004 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Signature

Aasheesh V. Shravah

Typed or Printed Name

CC:



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:	Toshimichi Kurihara, et al.	Examiner:	Nema O. Berezny
Serial No.:	09/942,445	Unit:	2813
Filed:	August 30, 2001	Docket:	14872
For:	SEMICONDUCTOR DEVICE IN A RESIN SEALED PACKAGE WITH A RADIATING PLATE AND MANUFACTURING METHOD THEREOF	Dated:	February 24, 2004

Conf. No.: 7920

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE


Sir:

In response to the Official Action dated November 24, 2003, Applicants respectfully request reconsideration of the above-identified application in light of the following amendments and remarks:

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on February 24, 2004.

Dated: February 24, 2004


Aasheesh V. Shravah